

AO6802

30V Dual N-Channel MOSFET

General Description

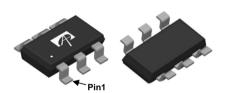
The AO6802 uses advanced trench technology to provide excellent $R_{\text{DS(ON)}}$ and low gate charge. This device is suitable for use as a load switch or in PWM applications.

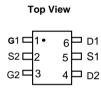
Product Summary

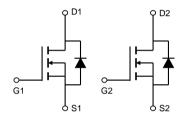
 $\begin{array}{ll} V_{DS} & 30V \\ I_{D} \; (at \, V_{GS} \! = \! 10V) & 3.5A \\ R_{DS(ON)} \; (at \, V_{GS} \! = \! 10V) & < 50 m\Omega \\ R_{DS(ON)} \; (at \, V_{GS} \! = \! 4.5V) & < 70 m\Omega \end{array}$











Absolute Maximum Ratings T_A=25°C unless otherwise noted

Parameter		Symbol	Maximum	Units	
Drain-Source Voltage		V _{DS}	30	V	
Gate-Source Voltage		V _{GS}	±20	V	
Continuous Drain	T _A =25°C		3.5		
Current	T _A =70°C	l _D	3	A	
Pulsed Drain Current ^C		I _{DM}	20		
	T _A =25°C	В	1.15	W	
Power Dissipation ^B	T _A =70°C	$-P_{D}$	0.73	VV	
Junction and Storage Temperature Range		T _J , T _{STG}	-55 to 150	°C	

Thermal Characteristics								
Parameter	Symbol	Тур	Max	Units				
Maximum Junction-to-Ambient A	t ≤ 10s	D	78	110	°C/W			
Maximum Junction-to-Ambient AD	Steady-State	$R_{\theta JA}$	106	150	°C/W			
Maximum Junction-to-Lead	Steady-State	$R_{\theta JL}$	64	80	°C/W			



Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units				
STATIC PARAMETERS										
BV _{DSS}	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	30			V				
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =30V, V _{GS} =0V			1	^				
		T _J =55°C			5	μΑ				
I_{GSS}	Gate-Body leakage current	V_{DS} =0V, V_{GS} = ±20V			±100	nA				
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS} I_{D}=250\mu A$	1.5	2	2.5	V				
$I_{D(ON)}$	On state drain current	V_{GS} =10V, V_{DS} =5V	20			Α				
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =3.5A		40	50	mΩ				
		T _J =125°C		61	77	11122				
		V_{GS} =4.5V, I_D =2A		52	70	mΩ				
g _{FS}	Forward Transconductance	V_{DS} =5V, I_D =3.5A		12		S				
V_{SD}	Diode Forward Voltage	I _S =1A,V _{GS} =0V		0.79	1	V				
Is	Maximum Body-Diode Continuous Current				1.5	Α				
DYNAMIC	PARAMETERS									
C _{iss}	Input Capacitance			210	275	pF				
Coss	Output Capacitance	V_{GS} =0V, V_{DS} =15V, f=1MHz		35		pF				
C _{rss}	Reverse Transfer Capacitance			23		pF				
R_g	Gate resistance	V_{GS} =0V, V_{DS} =0V, f=1MHz	0.7	1.5	3.0	Ω				
SWITCHII	NG PARAMETERS									
Q _g (10V)	Total Gate Charge			4.05	10	nC				
Q _g (4.5V)	Total Gate Charge	V _{GS} =10V, V _{DS} =15V, I _D =3.5A		2	6	nC				
Q_{gs}	Gate Source Charge	GS=10V, VDS=13V, ID=3.3A		0.55		nC				
Q_{gd}	Gate Drain Charge			1		nC				
t _{D(on)}	Turn-On DelayTime			4.5		ns				
t _r	Turn-On Rise Time	V_{GS} =10V, V_{DS} =15V, R_L =4.2 Ω ,		1.5		ns				
$t_{D(off)}$	Turn-Off DelayTime	$R_{GEN}=3\Omega$		18.5		ns				
t _f	Turn-Off Fall Time			1.5		ns				
t _{rr}	Body Diode Reverse Recovery Time	I _F =3.5A, dI/dt=100A/μs		7.5	13	ns				
Q_{rr}	Body Diode Reverse Recovery Charge	I _F =3.5A, dI/dt=100A/μs		2.5		nC				

A. The value of R_{iJA} is measured with the device mounted on 1in^2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25° C. The value in any given application depends on the user's specific board design. B. The power dissipation P_D is based on $T_{J(MAX)}$ =150° C, using \leq 10s junction-to-ambient thermal resistance.

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C. Repetitive rating, pulse width limited by junction temperature T_{J(MAX)}=150° C. Ratings are based on low frequency and duty cycles to keep initial $T_J\!\!=\!\!25^{\circ}$ C.

D. The $R_{\theta JA}$ is the sum of the thermal impedance from junction to lead $R_{\theta JL}$ and lead to ambient.

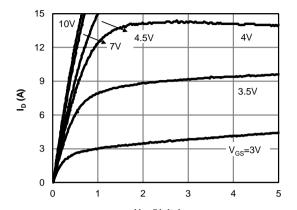
E. The static characteristics in Figures 1 to 6 are obtained using <300µs pulses, duty cycle 0.5% max.

F. These curves are based on the junction-to-ambient thermal impedance which is measured with the device mounted on 1in² FR-4 board with

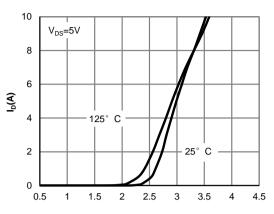
²oz. Copper, assuming a maximum junction temperature of T_{J(MAX)}=150° C. The SOA curve provides a single pulse rating.



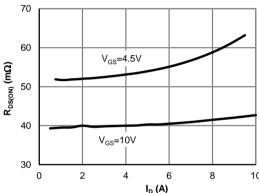
N-Channel: TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



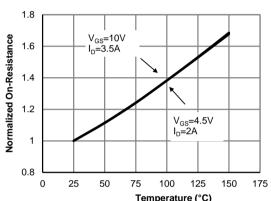
V_{DS} (Volts) Fig 1: On-Region Characteristics (Note E)



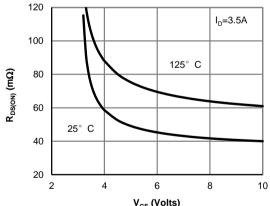
V_{GS}(Volts)
Figure 2: Transfer Characteristics (Note E)



I_D (A) Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)



Temperature (°C)
Figure 4: On-Resistance vs. Junction Temperature
(Note E)



V_{GS} (Volts)
Figure 5: On-Resistance vs. Gate-Source Voltage
(Note E)

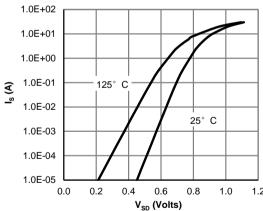
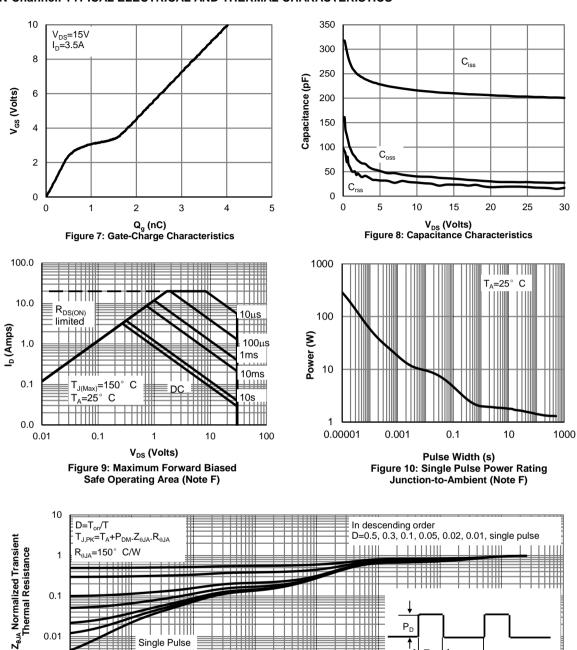


Figure 6: Body-Diode Characteristics (Note E)



N-Channel: TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



Pulse Width (s)
Figure 11: Normalized Maximum Transient Thermal Impedance (Note F)

10

100

1000

0.01

0.01

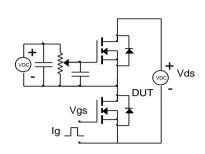
0.001 0.00001 Single Pulse

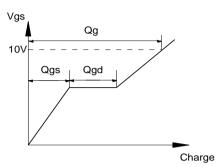
0.001

0.0001

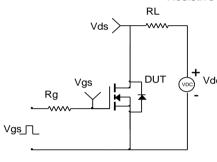


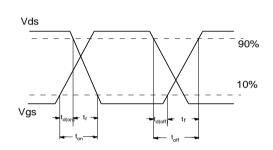
Gate Charge Test Circuit & Waveform



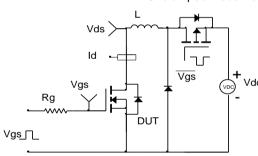


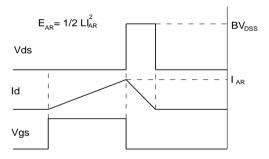
Resistive Switching Test Circuit & Waveforms





Unclamped Inductive Switching (UIS) Test Circuit & Waveforms





Diode Recovery Test Circuit & Waveforms

